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November 2015

FDMC4435BZ

P-Channel Power Trench[®] MOSFET -30 V, -18 A, 20 m Ω

Features

- Max $r_{DS(on)}$ = 20 m Ω at V_{GS} = -10 V, I_D = -8.5 A
- Max $r_{DS(on)}$ = 37 m Ω at V_{GS} = -4.5 V, I_D = -6.3 A
- \blacksquare Extended V_{GSS} range (-25 V) for battery applications
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability
- HBM ESD protection level >7 kV typical (Note 4)
- 100% UIL Tested
- Termination is Lead-free and RoHS Compliant

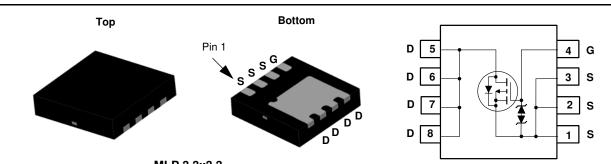


General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Applications

- High side in DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Paramo	eter		Ratings	Units
V _{DS}	Drain to Source Voltage			-30	V
V _{GS}	Gate to Source Voltage			±25	V
	Drain Current -Continuous	T _C = 25 °C		-18	
Ι _D	-Continuous	T _A = 25 °C	(Note 1a)	-8.5	Α
	-Pulsed			-50	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	32	mJ
P _D	Power Dissipation	T _C = 25 °C		31	14/
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	W
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (No	ote 1a)	53	C/ W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC4435BZ	FDMC4435BZ	MLP 3.3X3.3	13 "	12 mm	3000 units

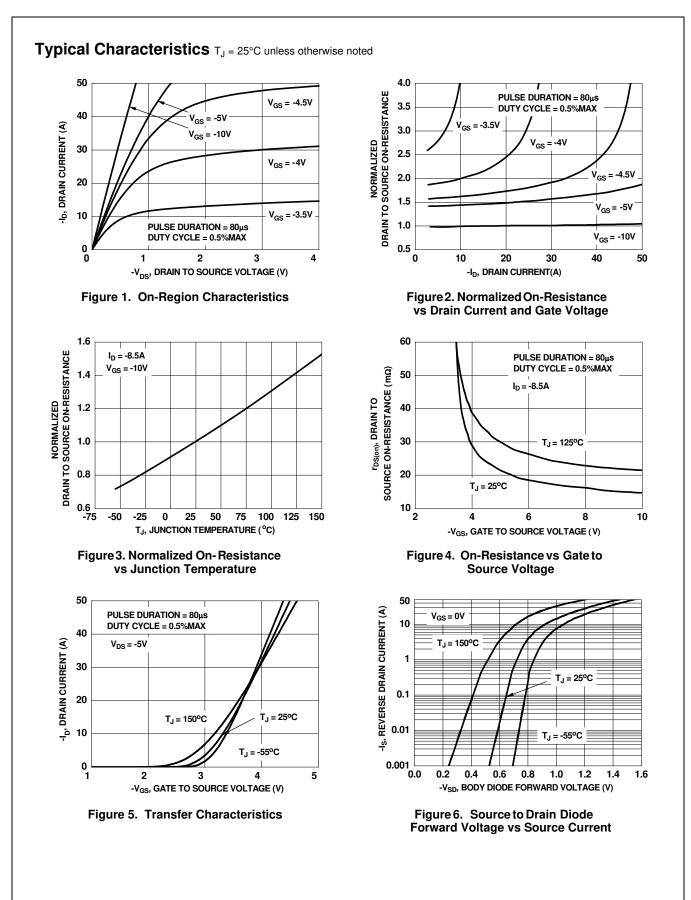
Drain to Source Breakdown Voltage		Min	Тур	Max	Units
	I _D = -250 μA, V _{GS} = 0 V	-30			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		21		mV/°0
Zero Gate Voltage Drain Current	$V_{DS} = -24 \text{ V}, \\ V_{GS} = 0 \text{ V}, \\ \hline T_J = 125 \text{ °C}$			-1 -100	μA
Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
cteristics					
	$V_{CS} = V_{DS}$, $I_{D} = -250 \ \mu A$	-1.0	-1.8	-3.0	V
Gate to Source Threshold Voltage	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		-5		mV/°C
	V _{GS} = -10 V, I _D = -8.5 A		14	20	
Statio Drain to Source On Registance	$V_{GS} = -4.5 \text{ V}, I_D = -6.3 \text{ A}$		21	37	mΩ
	$V_{GS} = -10 \text{ V}, \ \text{I}_{D} = -8.5 \text{ A},$ T _J = 125 °C		20	29	1115.2
Forward Transconductance	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -8.5 \text{ A}$		25		S
Characteristics					
			1535	2040	pF
			310	410	pF
	_t = 1 MHz		280	420	pF
Gate Resistance	f = 1 MHz		4		Ω
g Characteristics			1	1	1
Turn-On Delay Time			10	20	ns
Rise Time	Vpp = -15 V. lp = -8.5 A.		9	18	ns
Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		35	56	ns
Fall Time			19	34	ns
Total Gate Charge	V _{GS} =0V to -10V		38	53	nC
			20		nC
Gate to Source Charge	$I_{\rm D} = -8.5 \rm{A}$		4.3		nC
Gate to Drain "Miller" Charge			11		nC
ciato to Diani ininoi orialigo					
uras Diado Chorastoristico					
urce Diode Characteristics	$V_{00} = 0 V I_0 = -854$ (Note 2)		0.86	15	
urce Diode Characteristics Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -8.5A$ (Note 2) $V_{GS} = 0 V, I_S = -1.9 A$ (Note 2)		0.86	1.5 1.2	v
					V
	Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$ \begin{array}{c c} \mbox{Gate to Source Threshold Voltage} & V_{GS} = V_{DS}, \ I_D = -250 \ \mu \mbox{A} \\ \hline \mbox{Gate to Source Threshold Voltage} & I_D = -250 \ \mu \mbox{A}, \ referenced to 25 \ ^{\circ}\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	$ \begin{array}{ c c c c } \hline Gate to Source Threshold Voltage & V_{GS} = V_{DS}, \ I_D = -250 \ \mu A & -1.0 \\ \hline Gate to Source Threshold Voltage & I_D = -250 \ \mu A, referenced to 25 \ ^{\circ}C & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = -10 \ V, \ I_D = -8.5 \ A & V_{GS} = 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Temperature Coefficient \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline I_D = -250 \ ^{\circ}\text{A}, r_D = -8.5 \ ^{\circ}\text{A}, r_D = -8.5 \ ^{\circ}\text{A} \\ \hline I_D = -250 \ ^{\circ}\text{C} \\ \hline I_D $

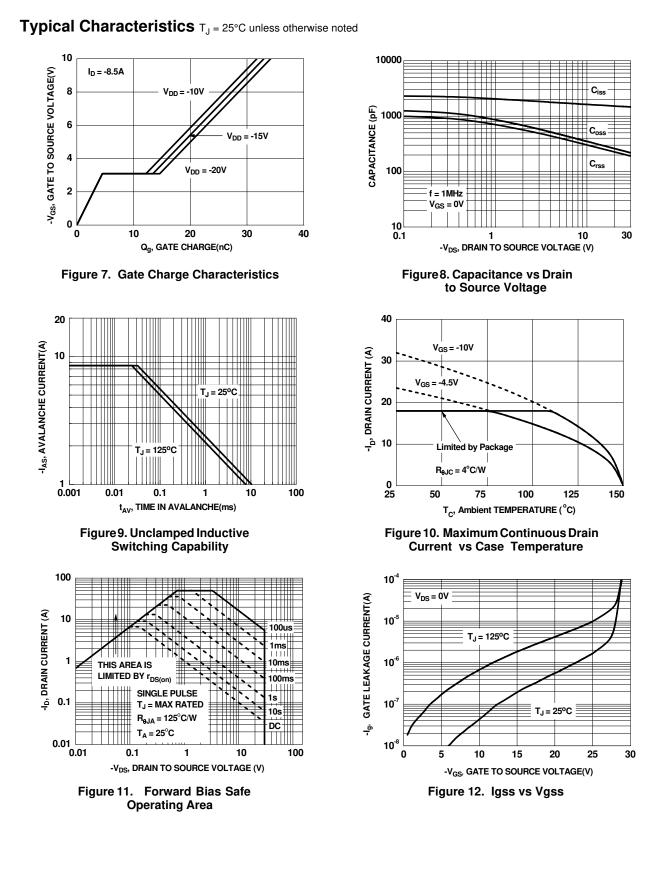
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

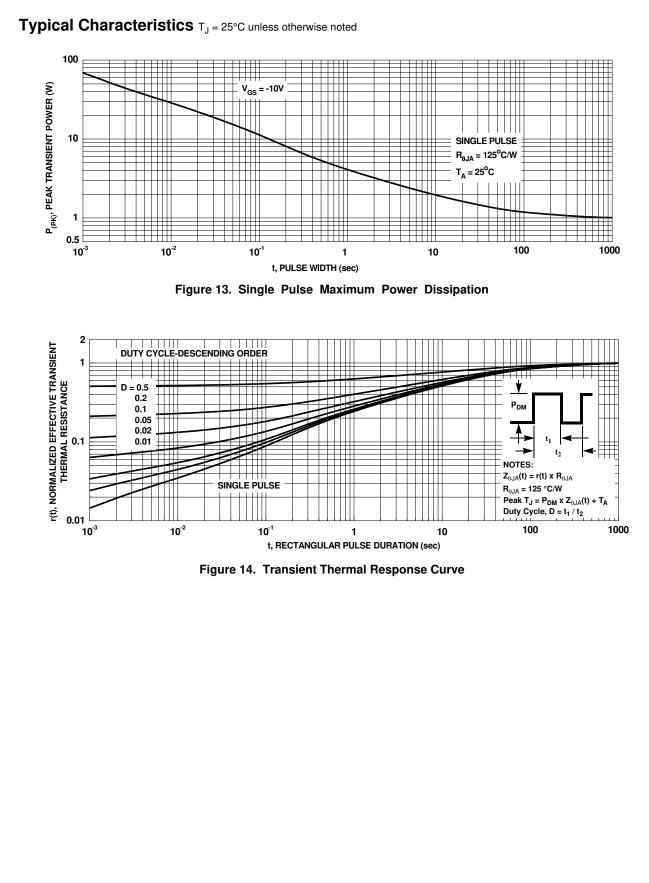
3. Starting T_J = 25°C; P-ch: L = 1mH, I_{AS} = -8A, V_{DD} = -27V, V_{GS} = -10V.

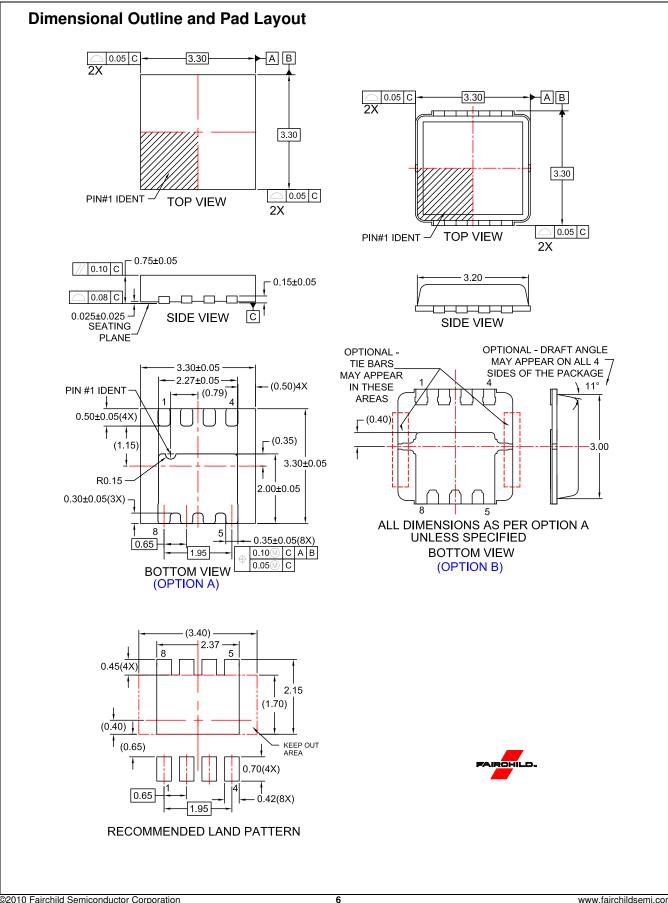
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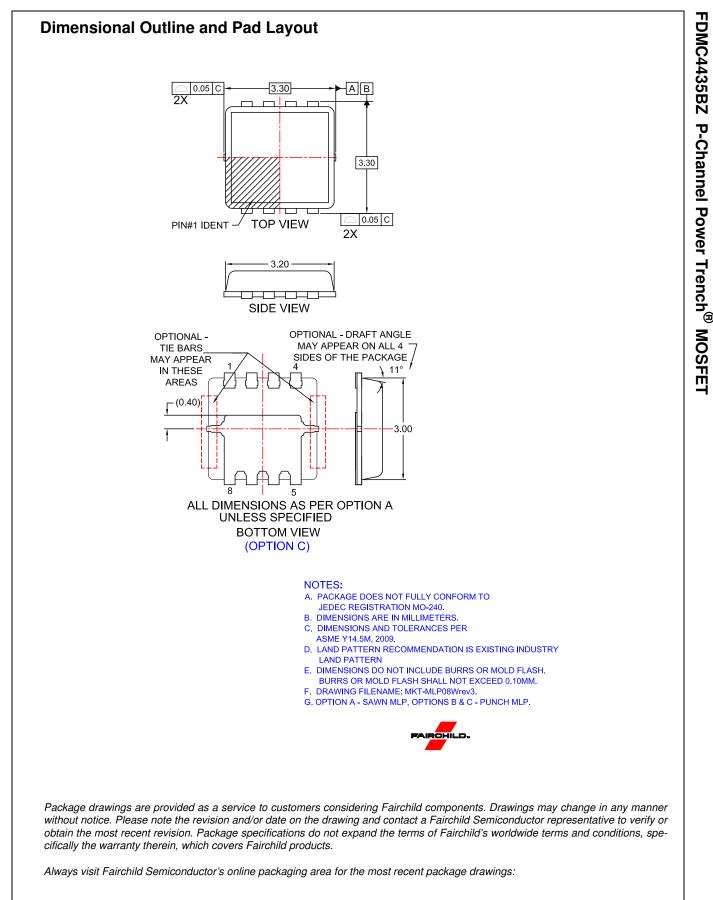
4. The diode connected between the gate and source servers only as protection against ESD. No gate overvoltage rating is implied.













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